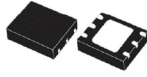


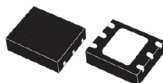
High PSRR, low drop linear regulator IC



SO-8



DFN6 (2x2)



DFN6 (3x3)

Features

- Input voltage from 2.5 V to 18 V
- 20 V AMR
- Any fixed output voltages, from 1.2 V to 12 V in 100 mV steps (from 1.2 V to 6.6 V in 50 mV steps) available on request
- Adjustable version from 1.18 V to $V_{IN} - V_{DROP(MAX)}$
- Guaranteed output current 1.2 A
- Typical dropout 350 mV @ 1.2 A
- Undervoltage lockout
- Enable function
- Internal thermal, current and power limitation
- High PSRR: 87 dB @ 120 Hz, 75 dB @ 1 kHz
- Operating temperature range: -40 °C to 125 °C
- Packages SO-8 batwing plastic micropackage, DFN6 (3x3) and DFN6 (2x2)

Applications

- Consumer
- Industrial
- SMPS
- Point-of-load
- DC-DC post-regulation

Maturity status link

LDL212

Description

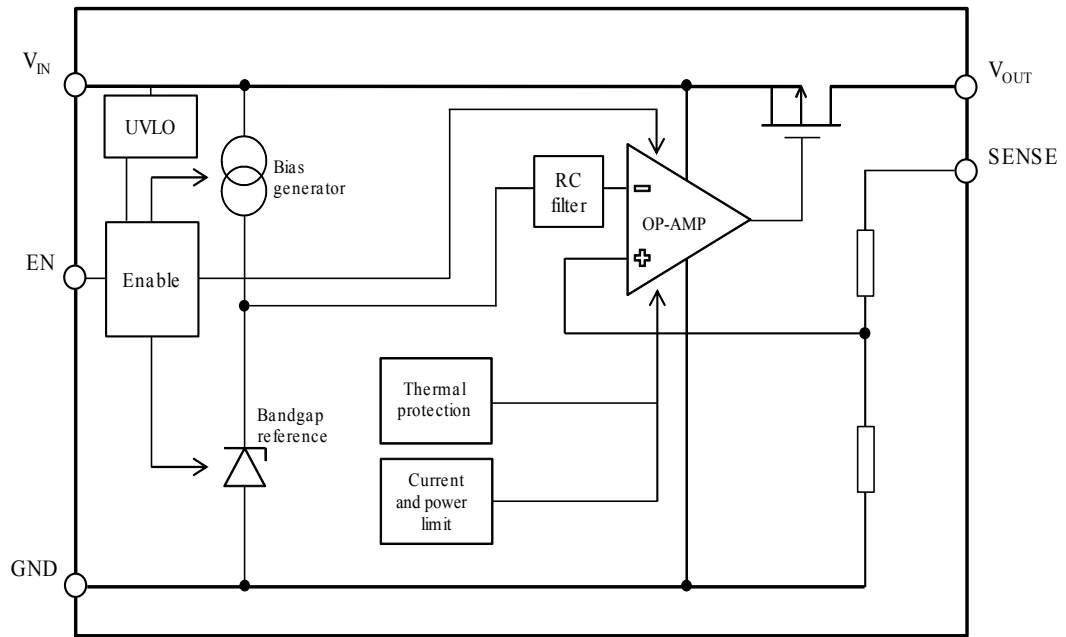
The **LDL212** provides 1.2 A of maximum current from an input voltage range from 2.5 V to 18 V, with a typical dropout voltage of 350 mV @ 1.2 A.

The high power supply rejection ratio of 87 dB at 120 Hz, and more than 40 dB at 100 kHz, makes the **LDL212** suitable for direct regulation in SMPS and secondary linear regulation in DC-DC converters. The **LDL212** goes to shutdown mode due to the enable logic control function, reducing the total current consumption.

The device also includes the current limit, SOA and thermal protections.

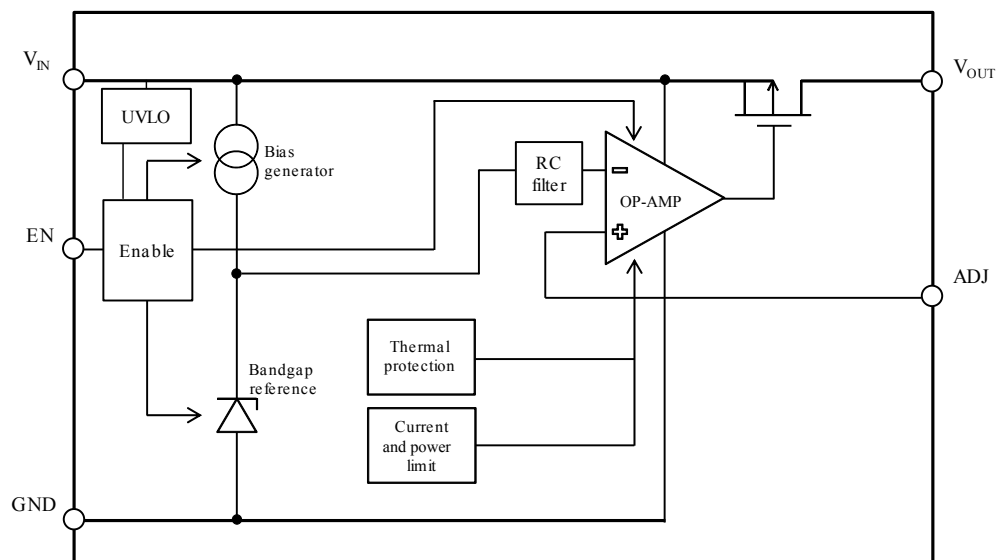
1 Block diagram

Figure 1. Block diagram (fixed)



GIPD251120151438MT

Figure 2. Block diagram (adjustable)



GIPD251120151438bMT

2 Pin configuration

Figure 3. Pin configuration (top view)



GIPD261120151015MT

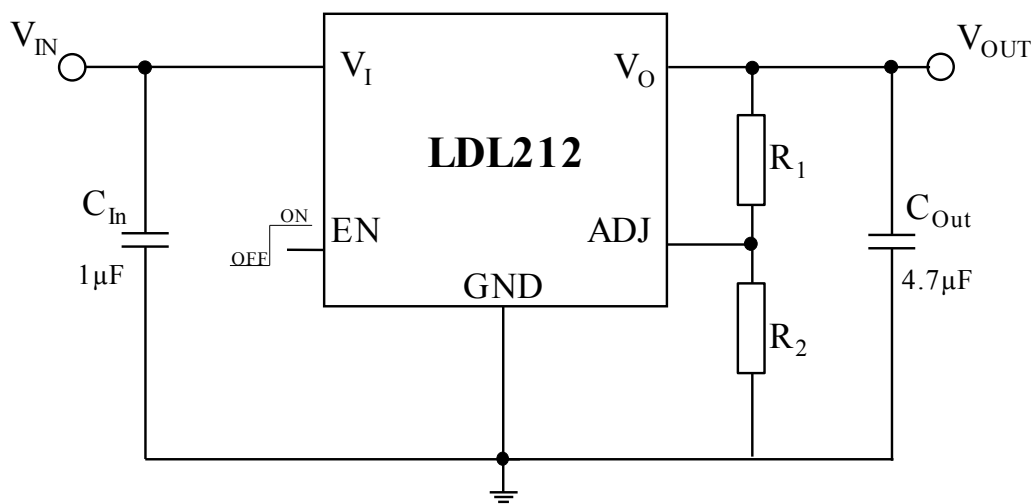
Table 1. Pin description

Pin name	Pin number (SO-8)	Pin number (DFN6)	Description
V_{IN}	4	4	Input voltage
V_{OUT}	1	3	Output voltage
GND	2, 3, 6, 7	1	Ground
ADJ/sense	8	2	Feedback pin for adjustable version / V_{OUT} sense on fixed version
EN	5	6	Enable pin. The device is in off-state when this pin is pulled low
NC	-	5	Not connected
GND	-	exposed pad	Exposed pad must be connected to GND

1. The sense pin on the fixed version must be connected to V_{OUT} for proper operation.

3 Typical application

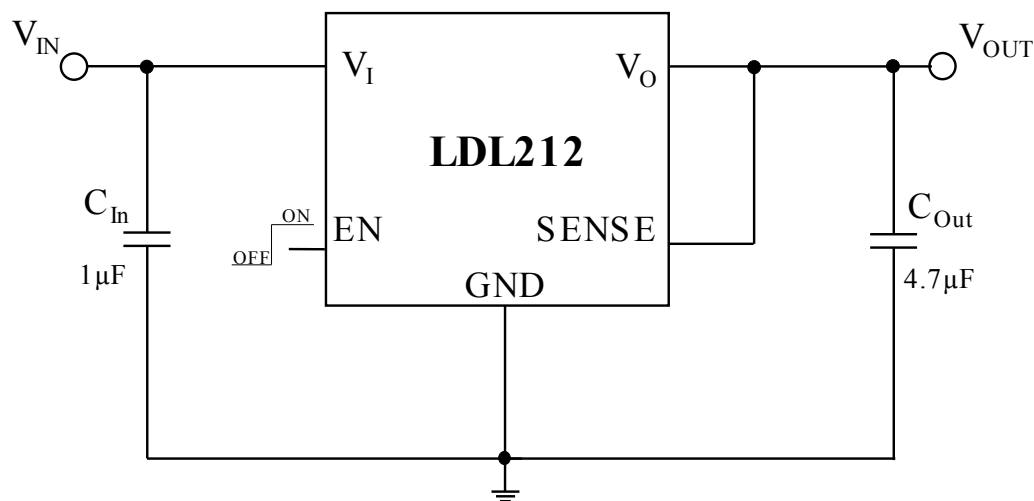
Figure 4. Typical application circuit (adjustable version)



Adjustable version

GIPD011220151346MT

Figure 5. Typical application circuit (fixed version)



Fixed version

GIPD011220151347MT

Note: *R1 and R2 are calculated according to the following formula: $R_1 = R_2 \times (V_{OUT}/V_{ADJ} - 1)$. The output voltage of the adjustable version can be set from 1.18 V to $V_{IN} - V_{DROP(MAX)}$, where $V_{DROP(MAX)}$ is the maximum dropout voltage, as defined in [Table 4. Electrical characteristics](#).*

4 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{IN}	DC input voltage	- 0.3 to 20	V
V_{OUT}	DC output voltage	- 0.3 to $V_{IN} + 0.3$	V
V_{EN}	Enable input voltage	- 0.3 to $V_{IN} + 0.3$	V
V_{SENSE}	Output sense pin voltage	- 0.3 to $V_{IN} + 0.3$	V
V_{ADJ}	ADJ pin voltage	- 0.3 to 2	V
I_{OUT}	Output current	Internally limited	mA
P_D	Power dissipation	Internally limited	mW
T_{STG}	Storage temperature range	- 55 to 150	°C
T_{OP}	Operating junction temperature range	- 40 to 125	°C

Note: *Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.*

Table 3. Thermal data

Symbol	Parameter	Value	Unit
SO-8 batwing plastic micropackage	Thermal resistance junction-to-case	20	°C/W
	Thermal resistance junction-to-ambient	55	
DFN6 (2x2)	Thermal resistance junction-to-case	15	
	Thermal resistance junction-to-ambient	65	
DFN6 (3x3)	Thermal resistance junction-to-case	10	
	Thermal resistance junction-to-ambient	55	

5 Electrical characteristics

$T_J = 25\text{ }^{\circ}\text{C}$, $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$, $C_{IN} = 1\text{ }\mu\text{F}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$, $I_{OUT} = 10\text{ mA}$, $V_{EN} = V_{IN}$, unless otherwise specified. (For $V_{OUT(NOM)} \leq 1.5\text{ V}$, $V_{IN} = 2.7\text{ V}$.)

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
V _{IN}	Operating input voltage		2.5		18	V	
V _{UVLO}	Turn-on threshold			2.3	2.4	V	
	Hysteresis			200		mV	
V _{OUT}	V _{OUT} accuracy	I _{OUT} = 10 mA	-2		2	%	
		T _J = 25 °C					
		I _{OUT} = 10 mA	-3		3	%	
		-40 °C < T _J < 125 °C					
V _{ADJ}	Adjustable pin voltage	V _{IN} = 2.5 V, I _{OUT} = 10 mA		1.18		V	
		T _J = 25 °C	-2		+2	%	
		V _{IN} = 2.5 V, I _{OUT} = 10 mA	-3		+3	%	
		-40 °C < T _J < 125 °C					
I _{ADJ}	Adjustable pin current	V _{IN} = 2.5 V, I _{OUT} = 10 mA		20		nA	
ΔV _{OUT}	Line regulation	V _{OUT} + 1 V ≤ V _{IN} ≤ 18 V, I _{OUT} = 10 mA		0.002	0.01	%/V	
ΔV _{OUT}	Load regulation	I _{OUT} = 10 mA to 1.2 A		0.0001	0.0005	%/mA	
V _{DROP}	Dropout voltage ⁽¹⁾	I _{OUT} = 1.2 A V _{OUT} > 3 V		350	600	mV	
	Dropout voltage for SO-8 ⁽¹⁾	-40 °C < T _J < 125 °C			700		
eN	Output noise voltage	10 Hz to 100 kHz, I _{OUT} = 100 mA		60		μV _{RMS} / V _{OUT}	
SVR	Supply voltage rejection	V _{IN} = V _{OUT(NOM)} + 1 V ± V _{RIPPLE}		87		dB	
		V _{RIPPLE} = 0.5 V, f = 120 Hz					
		V _{IN} = V _{OUT(NOM)} + 1 V ± V _{RIPPLE}		75			
		V _{RIPPLE} = 0.5 V, f = 1 kHz					
		V _{IN} = V _{OUT(NOM)} + 1 V ± V _{RIPPLE}		50			
		V _{RIPPLE} = 0.5 V, f = 100 kHz					
I _Q	Quiescent current	I _{OUT} = 0 mA to 1.2 A		250	380	μA	
		-40 °C < T _J < 125 °C					
		V _{IN} input current in OFF mode		0.3	1.5		
		V _{EN} = GND V _{IN} = 18 V					
I _{SC}	Short-circuit current	R _L = 0	1.5	2		A	
V _{EN}	Enable input logic low	V _{IN} = 2.5 V to 18 V			0.4	V	
		-40 °C < T _J < 85 °C					
	Enable input logic high	V _{IN} = 2.5 V to 18 V	1.2				

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{EN}		$-40\text{ }^{\circ}\text{C} < T_J < 85\text{ }^{\circ}\text{C}$				V
I_{EN}	Enable input current			1.5		μA
		$V_{EN} = V_{IN}, V_{IN} = 18\text{ V}$		16	20	
T_{ON}	Turn-on time ⁽²⁾			120		μs
T_{SHDN}	Thermal shutdown			175		$^{\circ}\text{C}$
	Hysteresis			25		

1. Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification is not valid for output voltages below 2.2 V.
2. Turn-on time is the time measured between the enable input just exceeding V_{EN} high value and the output voltage just reaching 95% of its nominal value.

6 Typical performance characteristics

Figure 6. Output voltage vs. temperature
($V_{IN} = 2.5\text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 0\text{ mA}$)

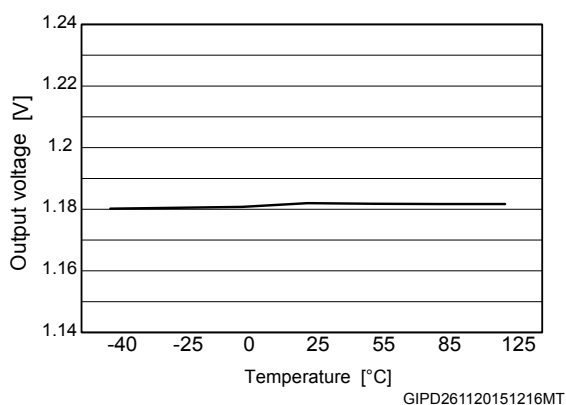


Figure 7. Output voltage vs. temperature
($V_{IN} = 2.5\text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 1200\text{ mA}$)

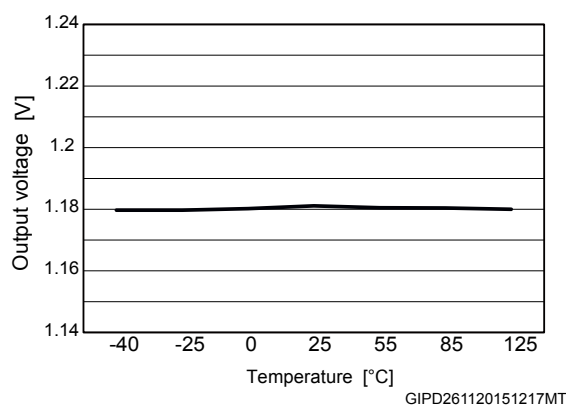


Figure 8. Output voltage vs. temperature ($V_{IN} = 6\text{ V}$, $V_{OUT} = 5\text{ V}$, $I_{OUT} = 10\text{ mA}$)

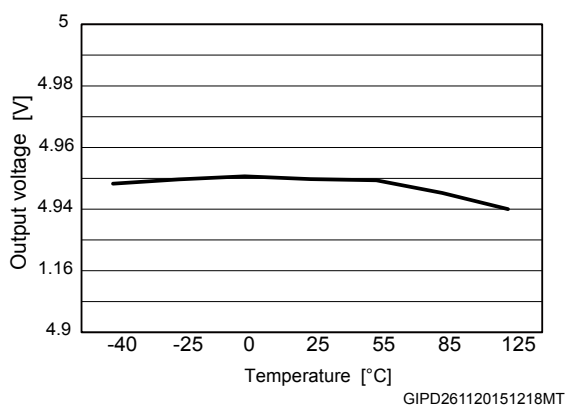


Figure 9. Output voltage vs. temperature ($V_{IN} = 6\text{ V}$, $V_{OUT} = 5\text{ V}$, $I_{OUT} = 1200\text{ mA}$)

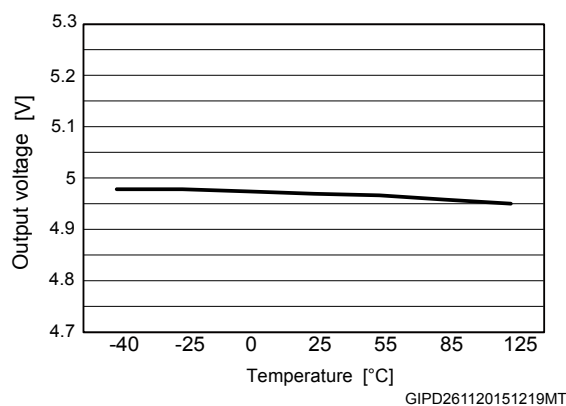


Figure 10. Line regulation vs. temperature ($V_{IN} = 6$ to 18 V, $V_{OUT} = 5$ V, $I_{OUT} = 10$ mA)

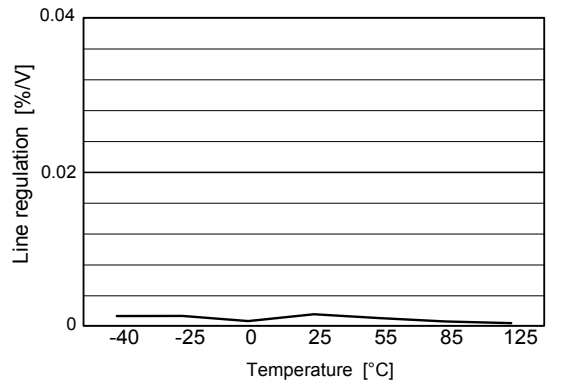


Figure 11. Line regulation vs. temperature ($V_{IN} = 2.5$ to 18 V, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 10$ mA)

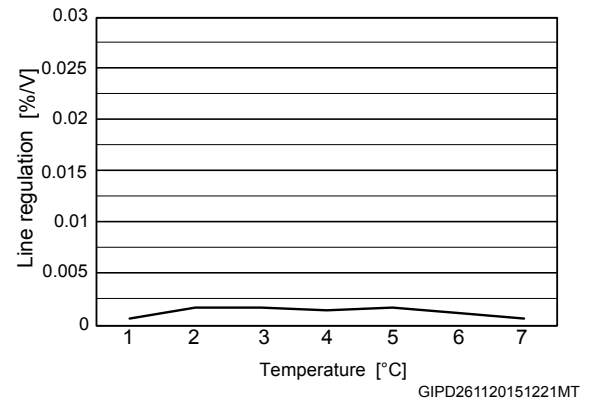


Figure 12. Load regulation vs. temperature ($V_{IN} = 6$ V, $V_{OUT} = 5$ V, $I_{OUT} = 10$ to 1200 mA)

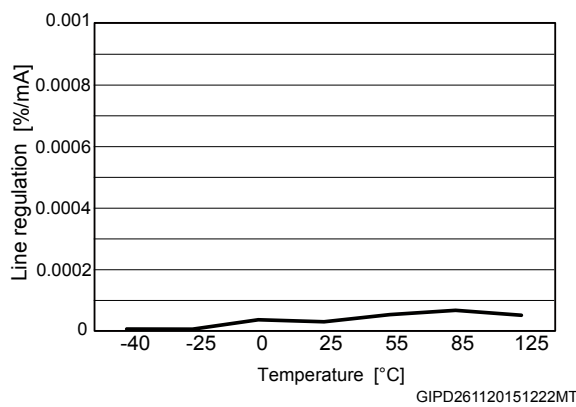


Figure 13. Load regulation vs. temperature ($V_{IN} = 2.5$ V, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 0$ to 1200 mA)

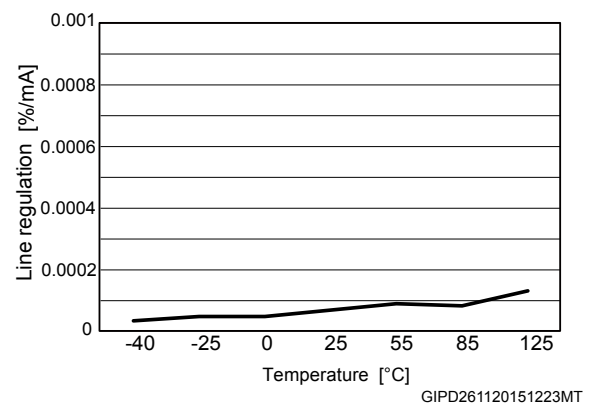


Figure 14. Enable thresholds vs. temperature ($V_{OUT} = V_{ADJ}$)

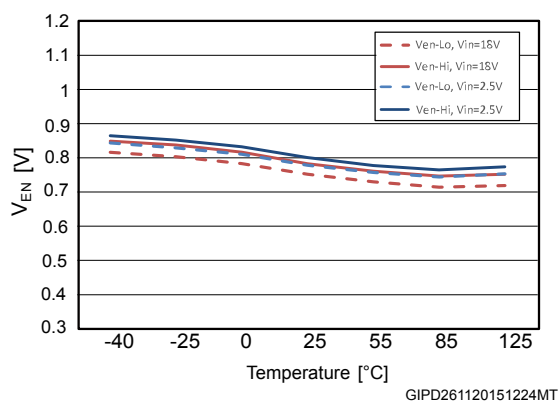


Figure 15. Enable thresholds vs. temperature ($V_{OUT} = 5$ V)

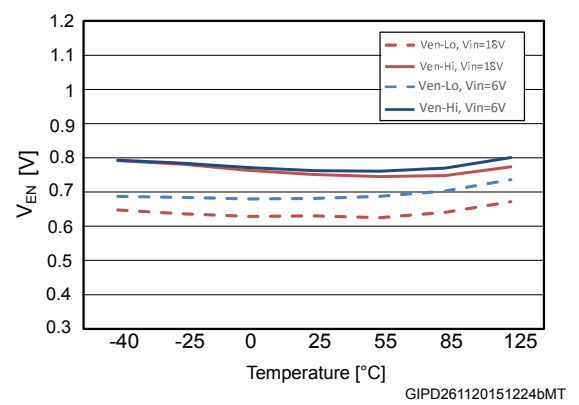
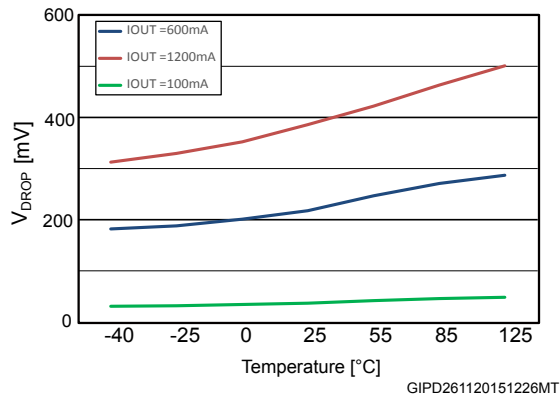
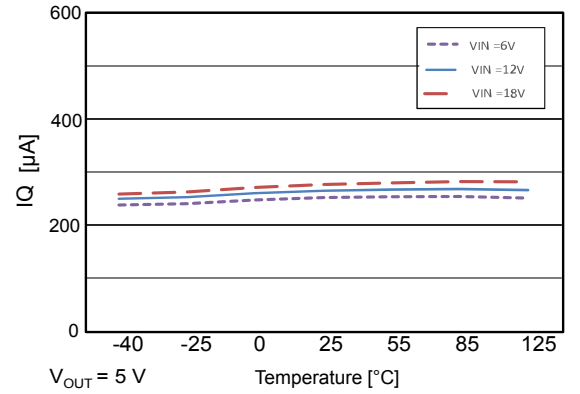
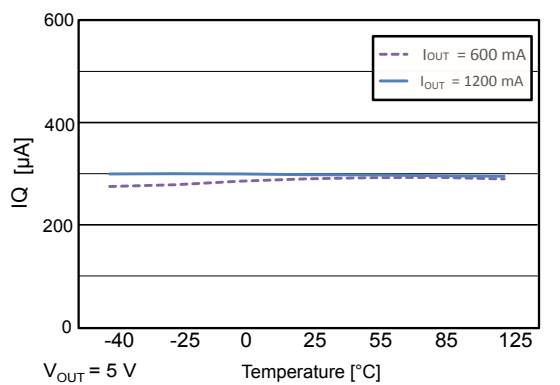


Figure 16. Dropout voltage vs. temperature


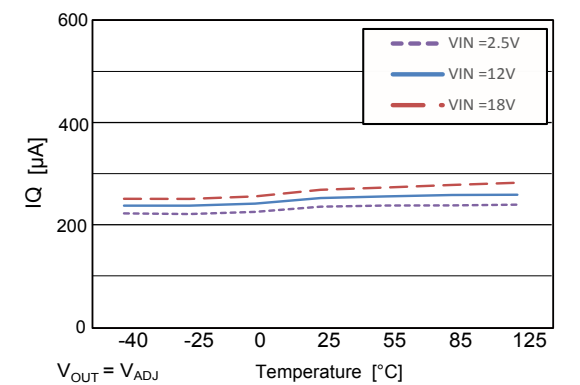
GIPD261120151226MT

Figure 17. Quiescent current vs. temperature ($V_{OUT} = 5\text{ V}$, $I_{OUT} = 0\text{ mA}$)


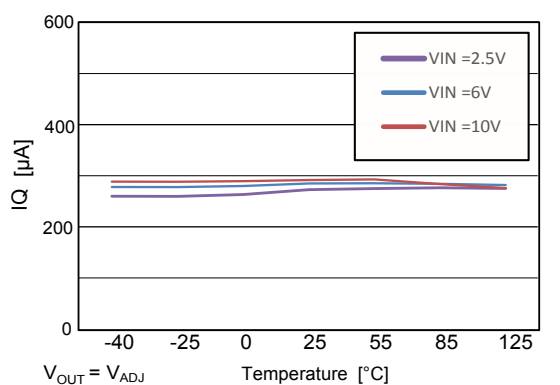
GIPD261120151226bMT

Figure 18. Quiescent current vs. temperature ($V_{OUT} = 5\text{ V}$, $I_{OUT} = 600\text{ mA}$, 1.2 A)


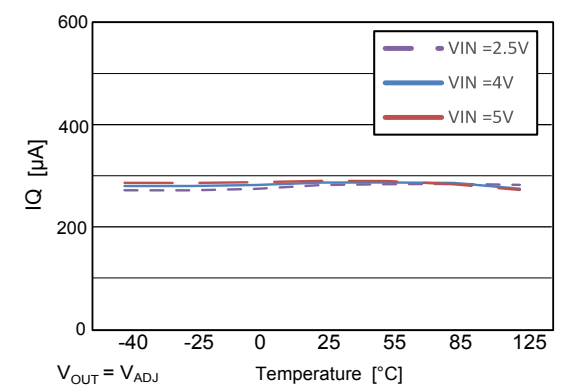
GIPD261120151227MT

Figure 19. Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 0\text{ mA}$)


GIPD261120151228MT

Figure 20. Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 600\text{ mA}$)


GIPD261120151229MT

Figure 21. Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 1.2\text{ A}$)


GIPD261120151230MT

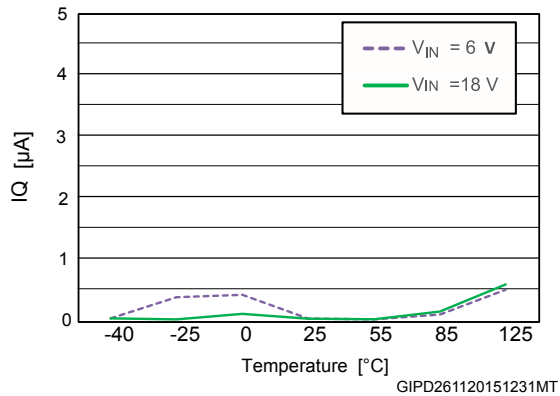
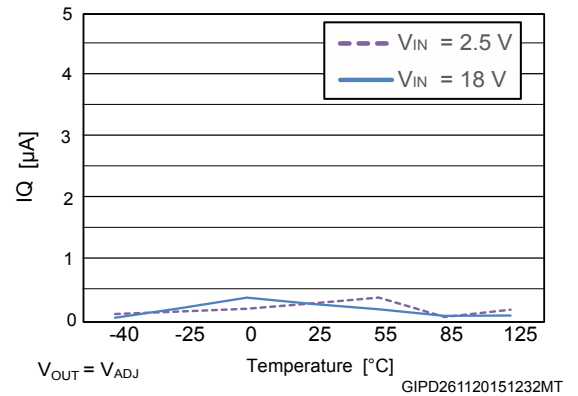
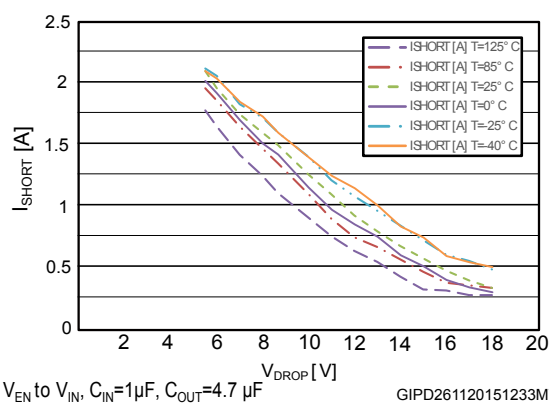
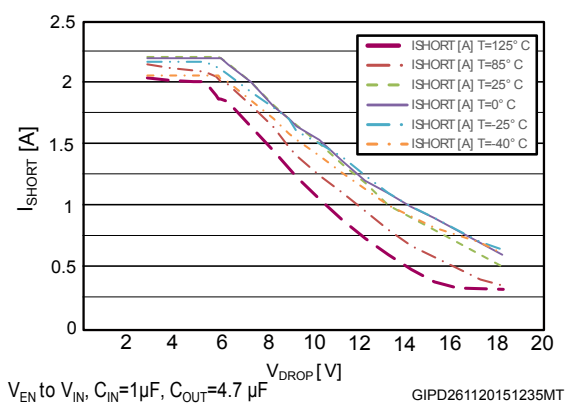
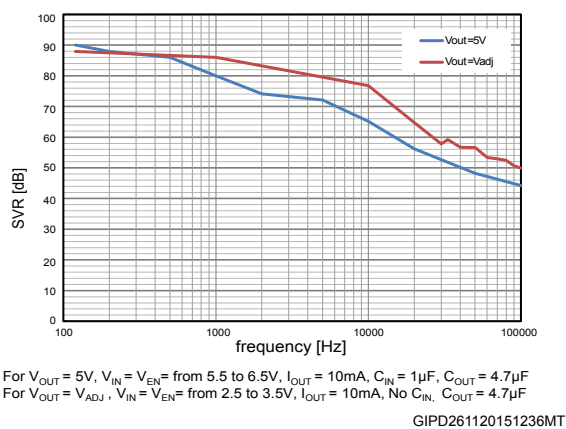
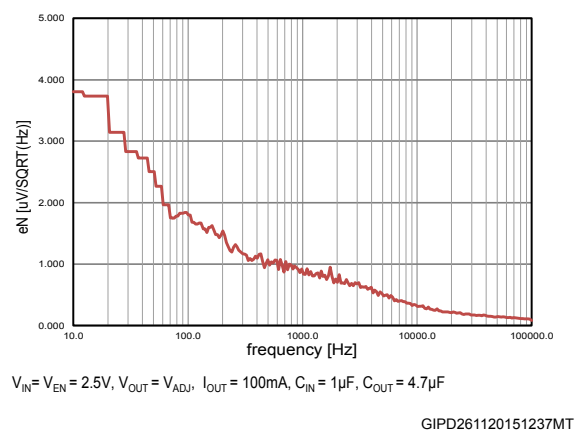
Figure 22. Off-state current vs. temperature
 $(V_{OUT} = 5\text{ V})$

Figure 23. Off-state current vs. temperature
 $(V_{OUT} = V_{ADJ})$

Figure 24. Short-circuit current vs. dropout voltage
 $(V_{OUT} = 5\text{ V})$

Figure 25. Short-circuit current vs. dropout voltage
 $(V_{OUT} = V_{ADJ})$

Figure 26. SVR vs. frequency

Figure 27. Output noise spectral density
 $(V_O = V_{ADJ})$


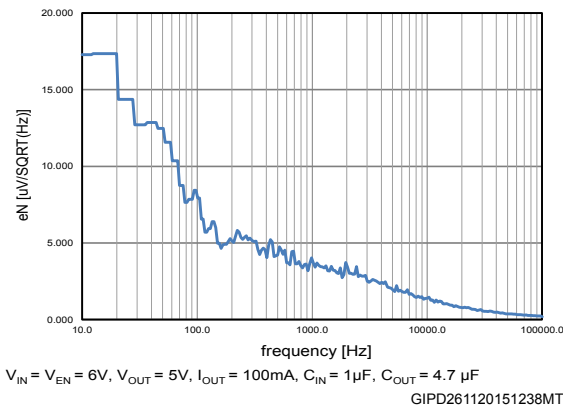
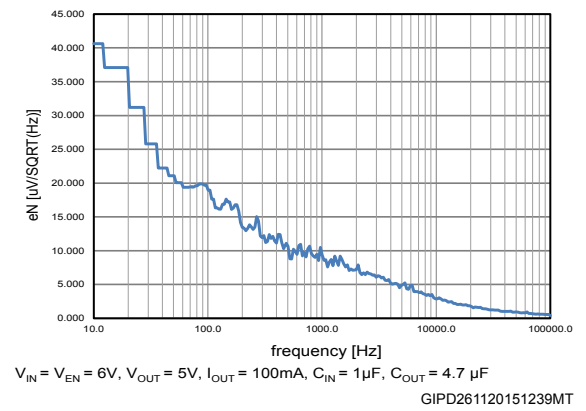
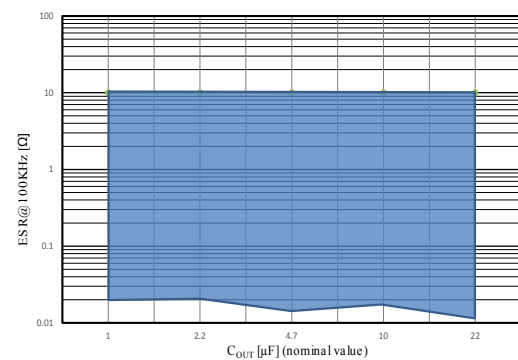
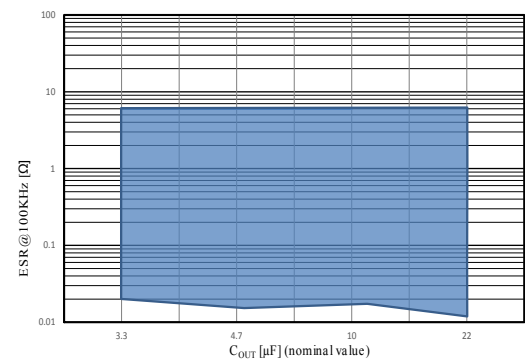
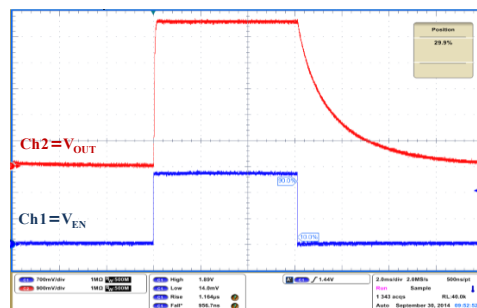
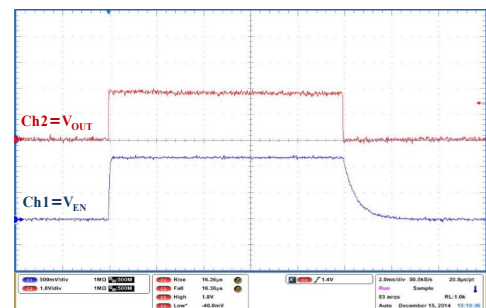
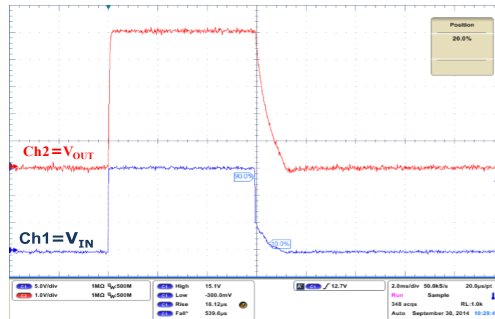
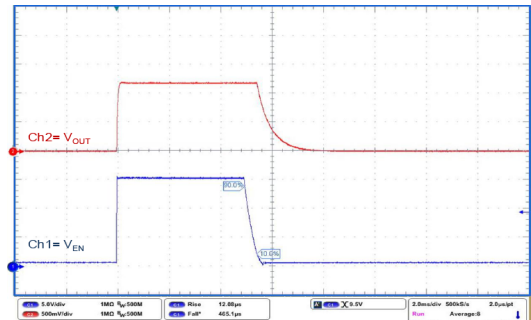
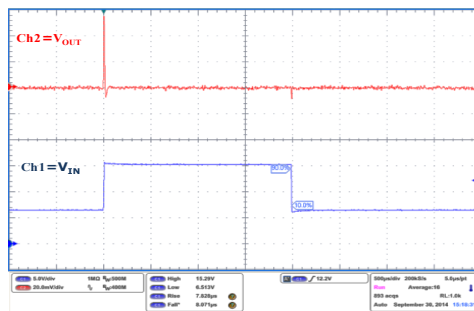
Figure 28. Output noise spectral density ($V_O = 5\text{ V}$)

Figure 29. Output noise spectral density ($V_O = 12\text{ V}$)

Figure 30. Stability plan ($V_{OUT} = 5\text{ V}$)

Figure 31. Stability plan ($V_{OUT} = V_{ADJ}$)

Figure 32. Startup with enable ($V_{OUT} = 5\text{ V}$)

Figure 33. Startup with enable ($V_{OUT} = V_{ADJ}$)


Figure 34. Turn-on time ($V_{OUT} = 5\text{ V}$)

 $V_{EN} = V_{IN}$ = from 0 to 15 V, $I_{OUT} = 10\text{ mA}$, $C_{OUT} = 1\text{ }\mu\text{F}$, $T_{rise} = 10\text{ }\mu\text{s}$

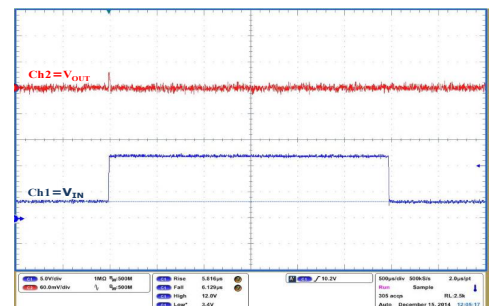
GIPD301120151407MT

Figure 35. Turn-on time ($V_{OUT} = V_{ADJ}$)

 $V_{EN} = V_{IN}$ = from 0 to 15 V, $I_{OUT} = 10\text{ mA}$, $C_{IN} = 1\text{ }\mu\text{F}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$, $t_{rise} = 10\text{ }\mu\text{s}$

GIPD301120151408MT

Figure 36. Line transient ($V_{OUT} = 5\text{ V}$)

 V_{IN} = from 6 to 15 V, $I_{OUT} = 10\text{ mA}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$, $t_r = 5\text{ }\mu\text{s}$

GIPD301120151409MT

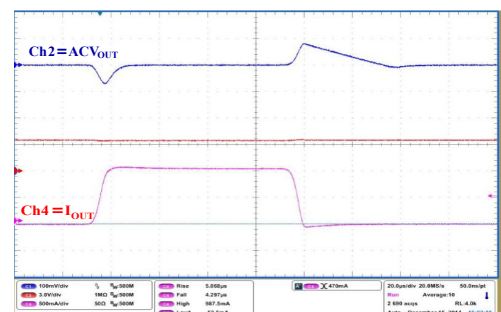
Figure 37. Line transient ($V_{OUT} = V_{ADJ}$)

 V_{IN} = from 3.5 to 15 V, $I_{OUT} = 10\text{ mA}$, NO C_{IN} , $C_{OUT} = 4.7\text{ }\mu\text{F}$, $t_r = 5\text{ }\mu\text{s}$

GIPD301120151410MT

Figure 38. Load transient ($V_{OUT} = 5\text{ V}$)

 V_{EN} to V_{CC} , $V_{IN} = 6\text{ V}$, I_{OUT} = from 10 mA to 1.2 A, $C_{IN} = 1\text{ }\mu\text{F}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$, $T_{rise} = 5\text{ }\mu\text{s}$

GIPD301120151411MT

Figure 39. Load transient ($V_{OUT} = V_{ADJ}$)

 V_{EN} to V_{CC} , $V_{IN} = 3.5\text{ V}$, I_{OUT} = from 10 mA to 1.2 A, $C_{IN} = 1\text{ }\mu\text{F}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$, $T_{rise} = 5\text{ }\mu\text{s}$

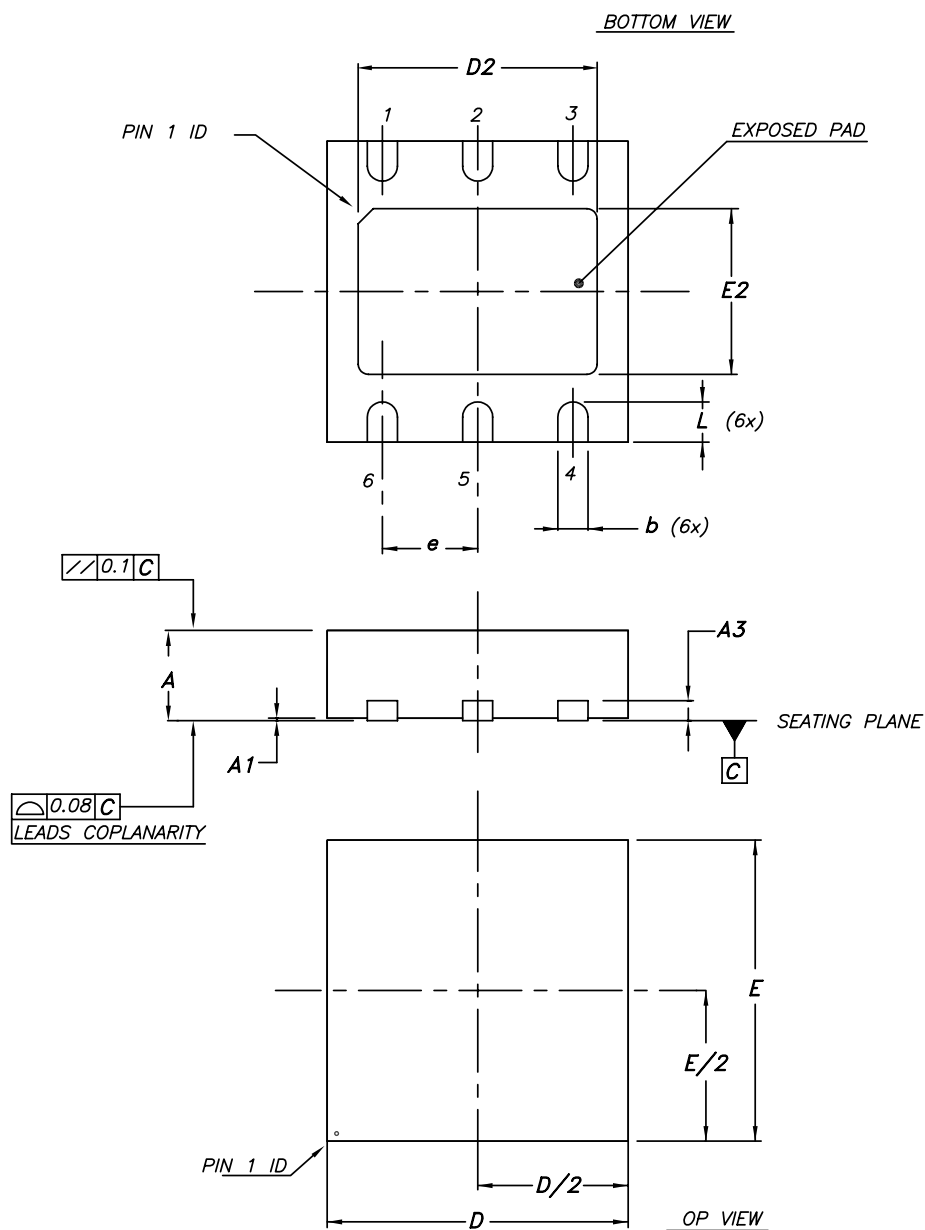
GIPD301120151412MT

7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

7.1 DFN6 (3x3) package information

Figure 40. DFN6 (3x3) package outline



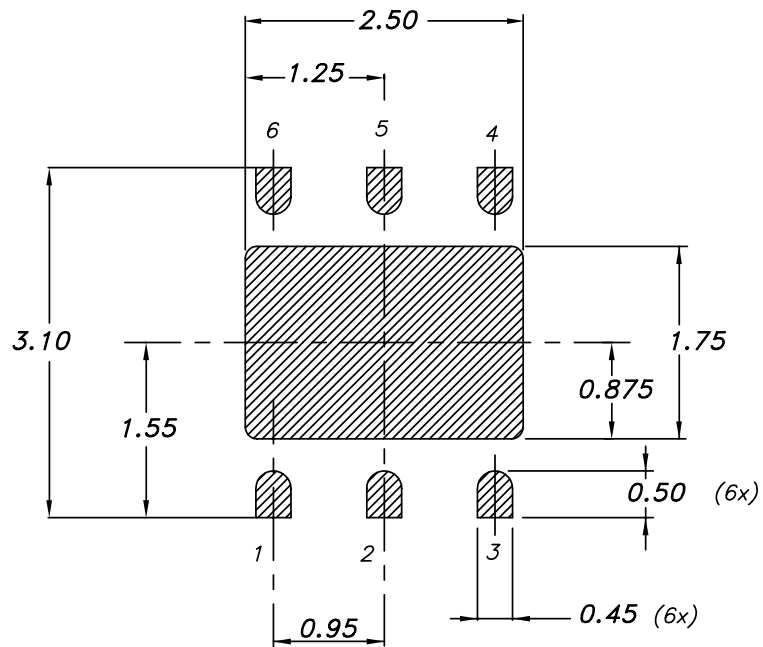
7946637_C

Table 5. DFN6 (3x3) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1
A1	0	0.02	0.05
A3		0.20	
b	0.23		0.45
D	2.90	3	3.10
D2	2.23		2.50
E	2.90	3	3.10
E2	1.50		1.75
e		0.95	
L	0.30	0.40	0.50

Figure 41. DFN6 (3x3) recommended footprint

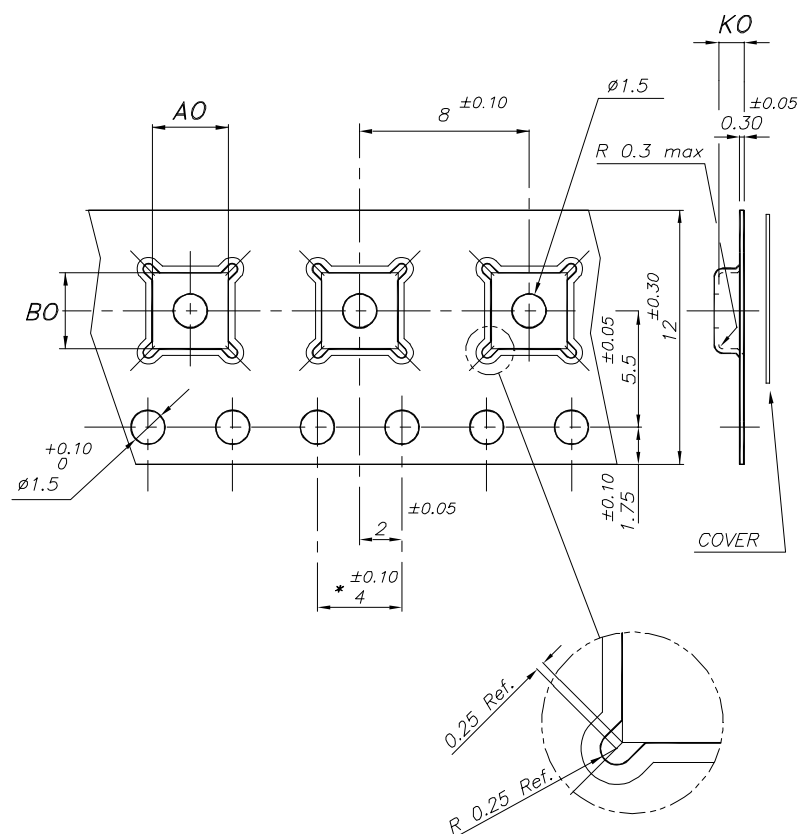
FOOTPRINT RECOMMENDED



7946637_C

7.2 DFN6 (3x3) packing information

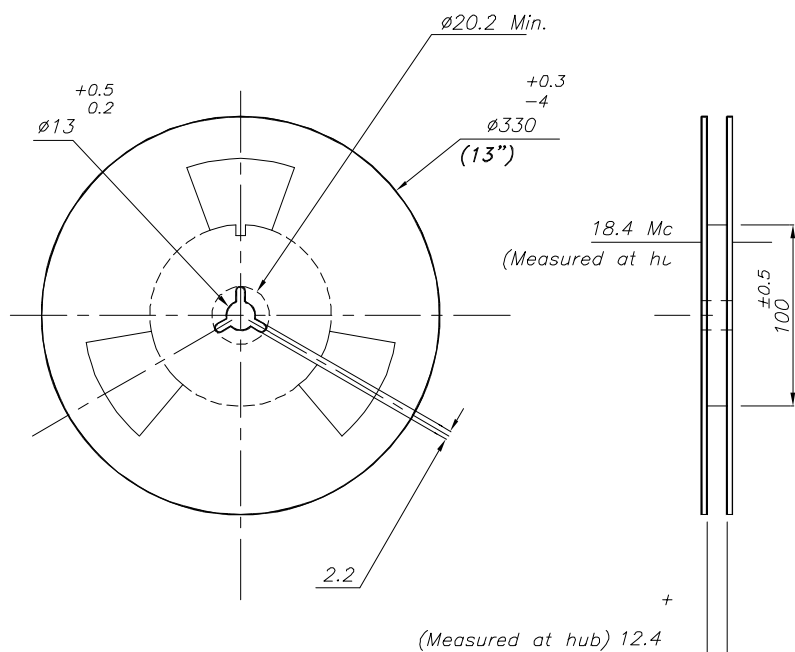
Figure 42. DFN6 (3x3) tape outline



*
- 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ± 0.20

7875978_N

Figure 43. DFN6 (3x3) reel outline



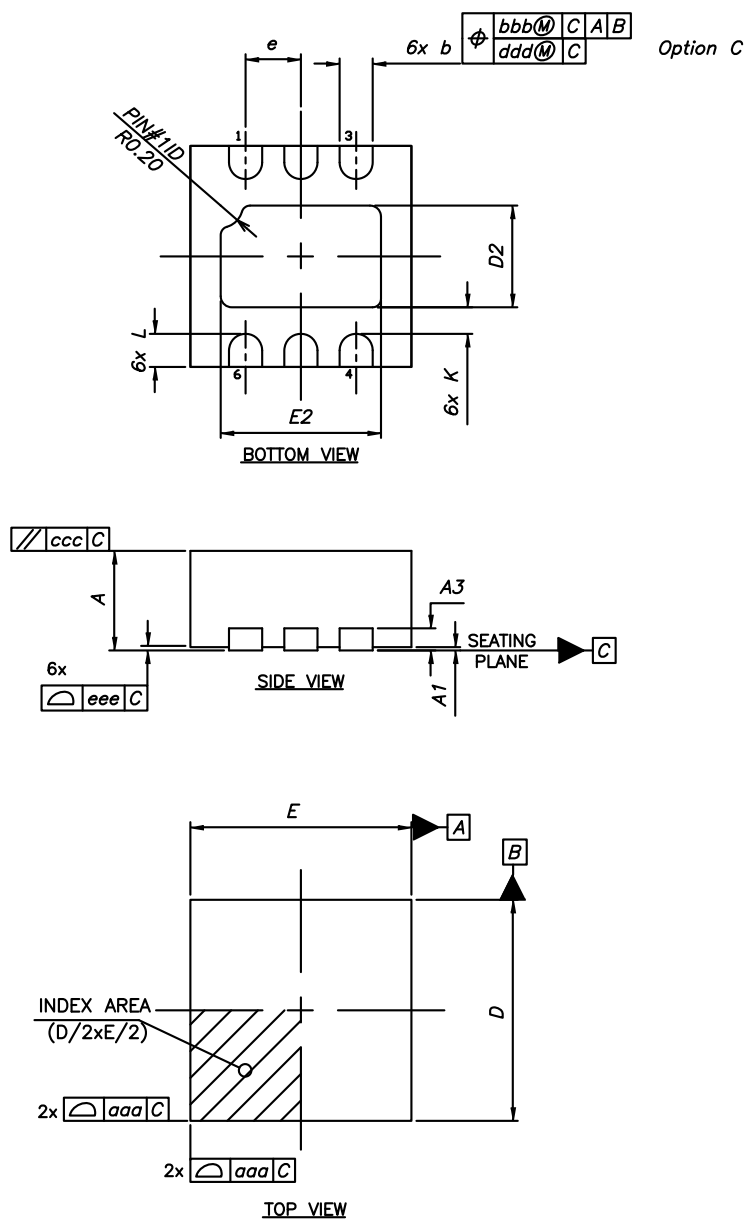
7875978_N

Table 6. DFN6 (3x3) tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A0	3.20	3.30	3.40
B0	3.20	3.30	3.40
K0	1	1.10	1.20

7.3 DFN6 (2x2) package information

Figure 44. DFN6 (2x2) package outline

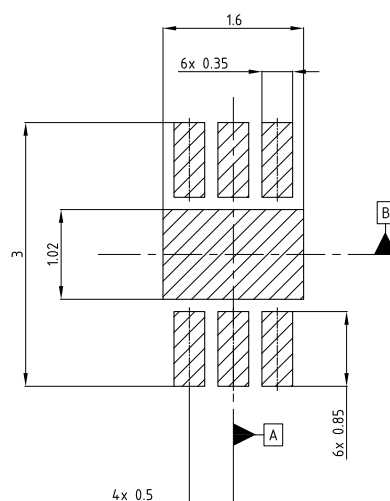


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Table 7. DFN6 (2x2) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	-	0.203 ref	-
b	0.25	0.30	0.35
D	-	2.00	-
E	-	2.00	-
e	-	0.50	-
D2	0.77	0.92	1.02
E2	1.30	1.45	1.55
K	0.15	-	-
L	0.20	0.30	0.40
aaa	-	0.05	-
bbb	-	0.10	-
ccc	-	0.10	-
ddd	-	0.05	-
eee	-	0.08	-

Figure 45. DFN6 (2x2) recommended footprint



Notes:

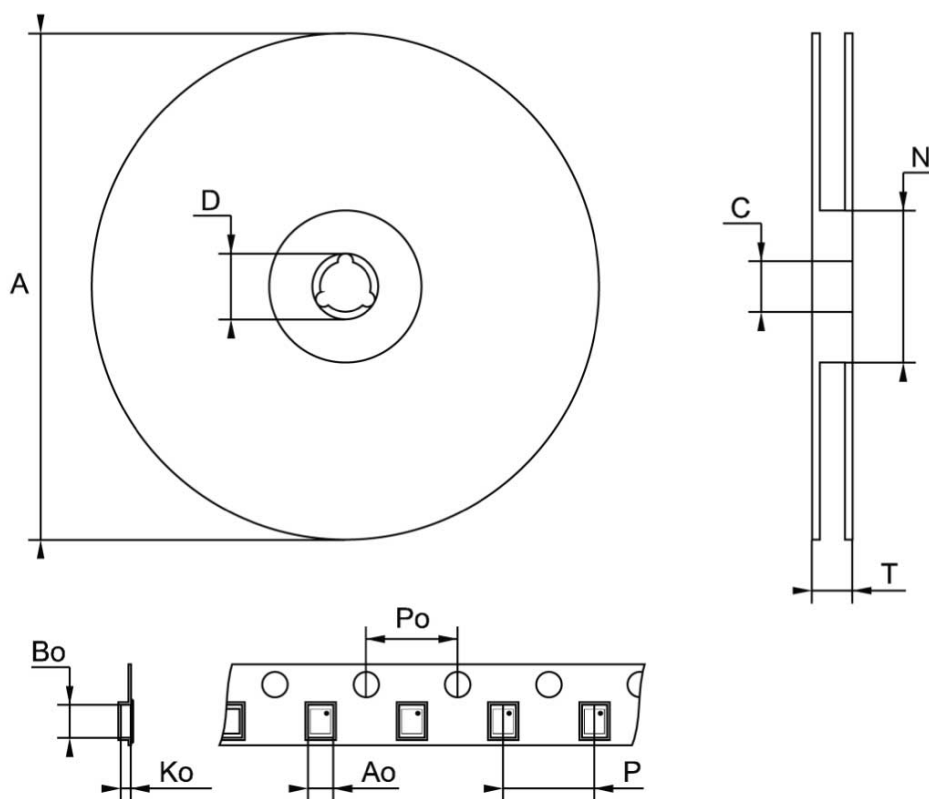
- 2) The device must be positioned within

$\oplus$	0.02	A	B
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7733060 revE

7.4 DFN6 (2x2) packing information

Figure 46. DFN6 (2 x 2 mm) reel outline



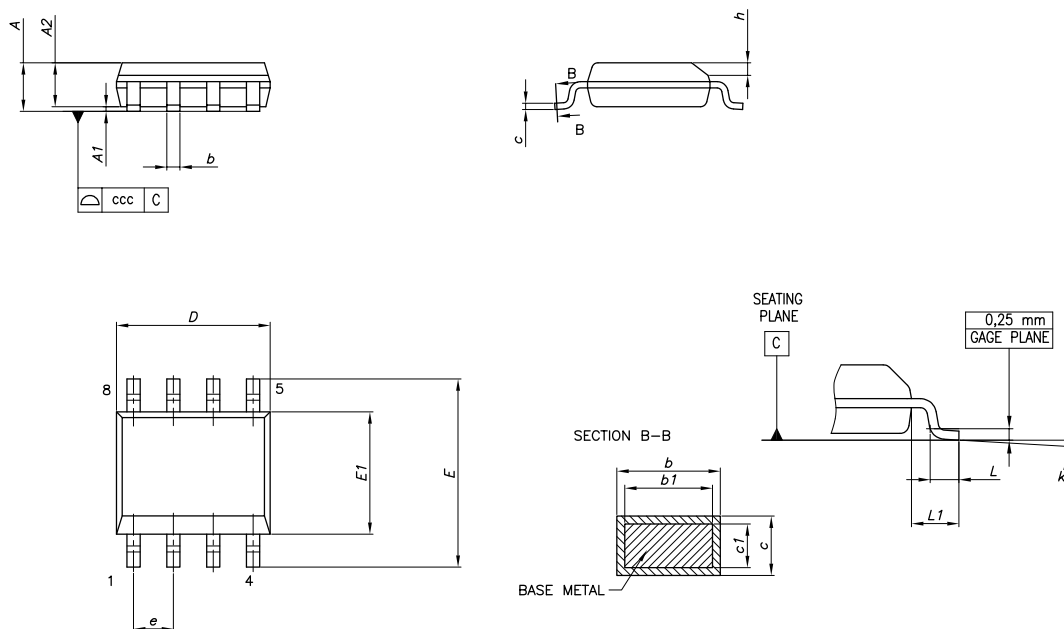
Note: Drawing not in scale

Table 8. DFN6 (2 x 2 mm) tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			180
C	12.8		13.2
D	20.2		
N	60		
T			14.4
A0		2.4	
B0		2.4	
K0		1.3	
P0		4	
P		4	

7.5 SO8 package information

Figure 47. SO-8 batwing package outline

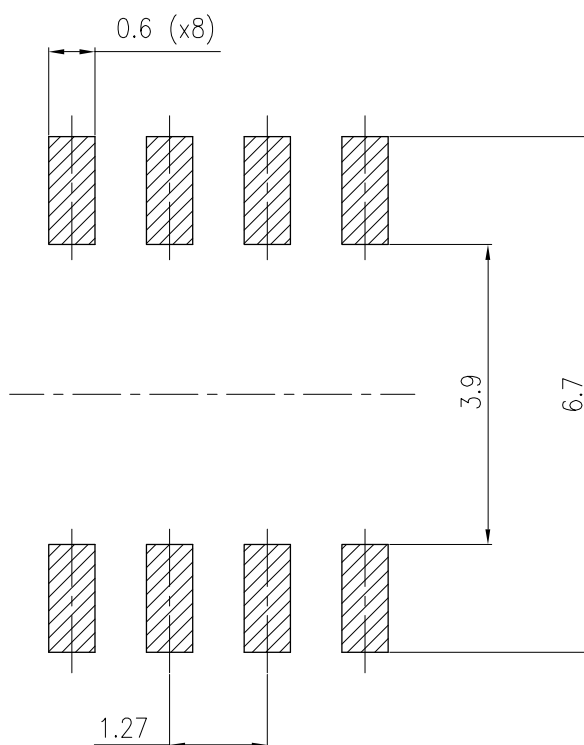


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Table 9. SO-8 batwing mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
c	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
ccc			0.10

Figure 48. SO-8 batwing recommended footprint



0016023_GU

8 Ordering information

Table 10. Order code

DFN6 (3x3)	DFN6 (2x2)	SO-8 batwing plastic micropackage	Output voltage (V)
LDL212PU12R ⁽¹⁾			1.2
LDL212PU15R			1.5
LDL212PU18R ⁽¹⁾			1.8
LDL212PU25R ⁽¹⁾			2.5
LDL212PU30R ⁽¹⁾			3
	LDL212PV33R	LDL212D33R	3.3
LDL212PU50R			5
LDL212PUR	LDL212PVR	LDL212DR	Adjustable

1. Available on request.

Revision history

Table 11. Document revision history

Date	Revision	Changes
02-Mar-2016	1	Initial release.
19-Sep-2016	2	Updated Table 3: "Thermal data" and Section 5: "Electrical characteristics". Minor text changes.
17-Sep-2018	3	Added: GND pin name in Table 1. Pin description and new order code LDL212D33R in Table 10. Order code.
16-Apr-2019	4	In Table 10. Order code, in LDL2012D33R the note has been removed. Updated GND description in Table 1. Pin description.
21-Feb-2020	5	Added dropout voltage for SO-8 in Table 4. Electrical characteristics .

Contents

1	Block diagram	2
2	Pin configuration	3
3	Typical application.....	4
4	Maximum ratings	5
5	Electrical characteristics.....	6
6	Typical performance characteristics	8
7	Package information.....	14
7.1	DFN6 (3x3) package information	14
7.2	DFN6 (3x3) packing information	16
7.3	DFN6 (2x2) package information	18
7.4	DFN6 (2x2) packing information	20
7.5	SO8-batwing package information	21
7.6	SO8-batwing packing information	0
8	Ordering information	23
	Revision history	24
	Contents	25
	List of tables	26
	List of figures.....	27

List of tables

Table 1.	Pin description	3
Table 2.	Absolute maximum ratings	5
Table 3.	Thermal data	5
Table 4.	Electrical characteristics	6
Table 5.	DFN6 (3x3) mechanical data	15
Table 6.	DFN6 (3x3) tape and reel mechanical data	17
Table 7.	DFN6 (2x2) mechanical data	19
Table 8.	DFN6 (2 x 2 mm) tape and reel mechanical data	20
Table 9.	SO-8 batwing mechanical data	21
Table 10.	Order code	23
Table 11.	Document revision history	24

List of figures

Figure 1.	Block diagram (fixed).	2
Figure 2.	Block diagram (adjustable).	2
Figure 3.	Pin configuration (top view)	3
Figure 4.	Typical application circuit (adjustable version).	4
Figure 5.	Typical application circuit (fixed version).	4
Figure 6.	Output voltage vs. temperature ($V_{IN} = 2.5\text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 0\text{ mA}$)	8
Figure 7.	Output voltage vs. temperature ($V_{IN} = 2.5\text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 1200\text{ mA}$)	8
Figure 8.	Output voltage vs. temperature ($V_{IN} = 6\text{ V}$, $V_{OUT} = 5\text{ V}$, $I_{OUT} = 10\text{ mA}$)	8
Figure 9.	Output voltage vs. temperature ($V_{IN} = 6\text{ V}$, $V_{OUT} = 5\text{ V}$, $I_{OUT} = 1200\text{ mA}$)	8
Figure 10.	Line regulation vs. temperature ($V_{IN} = 6\text{ to }18\text{ V}$, $V_{OUT} = 5\text{ V}$, $I_{OUT} = 10\text{ mA}$)	9
Figure 11.	Line regulation vs. temperature ($V_{IN} = 2.5\text{ to }18\text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 10\text{ mA}$)	9
Figure 12.	Load regulation vs. temperature ($V_{IN} = 6\text{ V}$, $V_{OUT} = 5\text{ V}$, $I_{OUT} = 10\text{ to }1200\text{ mA}$)	9
Figure 13.	Load regulation vs. temperature ($V_{IN} = 2.5\text{ V}$, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 0\text{ to }1200\text{ mA}$)	9
Figure 14.	Enable thresholds vs. temperature ($V_{OUT} = V_{ADJ}$)	9
Figure 15.	Enable thresholds vs. temperature ($V_{OUT} = 5\text{ V}$)	9
Figure 16.	Dropout voltage vs. temperature	10
Figure 17.	Quiescent current vs. temperature ($V_{OUT} = 5\text{ V}$, $I_{OUT} = 0\text{ mA}$)	10
Figure 18.	Quiescent current vs. temperature ($V_{OUT} = 5\text{ V}$, $I_{OUT} = 600\text{ mA}$, 1.2 A)	10
Figure 19.	Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 0\text{ mA}$)	10
Figure 20.	Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 600\text{ mA}$)	10
Figure 21.	Quiescent current vs. temperature ($V_{OUT} = V_{ADJ}$, $I_{OUT} = 1.2\text{ A}$)	10
Figure 22.	Off-state current vs. temperature ($V_{OUT} = 5\text{ V}$)	11
Figure 23.	Off-state current vs. temperature ($V_{OUT} = V_{ADJ}$)	11
Figure 24.	Short-circuit current vs. dropout voltage ($V_{OUT} = 5\text{ V}$)	11
Figure 25.	Short-circuit current vs. dropout voltage ($V_{OUT} = V_{ADJ}$)	11
Figure 26.	SVR vs. frequency	11
Figure 27.	Output noise spectral density ($V_O = V_{ADJ}$)	11
Figure 28.	Output noise spectral density ($V_O = 5\text{ V}$)	12
Figure 29.	Output noise spectral density ($V_O = 12\text{ V}$)	12
Figure 30.	Stability plan ($V_{OUT} = 5\text{ V}$)	12
Figure 31.	Stability plan ($V_{OUT} = V_{ADJ}$)	12
Figure 32.	Startup with enable ($V_{OUT} = 5\text{ V}$)	12
Figure 33.	Startup with enable ($V_{OUT} = V_{ADJ}$)	12
Figure 34.	Turn-on time ($V_{OUT} = 5\text{ V}$)	13
Figure 35.	Turn-on time ($V_{OUT} = V_{ADJ}$)	13
Figure 36.	Line transient ($V_{OUT} = 5\text{ V}$)	13
Figure 37.	Line transient ($V_{OUT} = V_{ADJ}$)	13
Figure 38.	Load transient ($V_{OUT} = 5\text{ V}$)	13
Figure 39.	Load transient ($V_{OUT} = V_{ADJ}$)	13
Figure 40.	DFN6 (3x3) package outline	14
Figure 41.	DFN6 (3x3) recommended footprint	15
Figure 42.	DFN6 (3x3) tape outline	16
Figure 43.	DFN6 (3x3) reel outline	17
Figure 44.	DFN6 (2x2) package outline	18
Figure 45.	DFN6 (2x2) recommended footprint	19
Figure 46.	DFN6 (2 x 2 mm) reel outline	20
Figure 47.	SO-8 batwing package outline	21
Figure 48.	SO-8 batwing recommended footprint	22

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